



**IPC-7527**  
**2012 - May**

**Requirements for Solder  
Paste Printing**

*A standard developed by IPC*

*Association Connecting Electronics Industries*



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In May 1995 the IPC's Technical Activities Executive Committee (TAEC) adopted Principles of Standardization as a guiding principle of IPC's standardization efforts.

**Standards Should:**

- Show relationship to Design for Manufacturability (DFM) and Design for the Environment (DFE)
- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

**Standards Should Not:**

- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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# Requirements for Solder Paste Printing

Developed by the Solder Paste Printing Task Group Nordic (5-21JND)  
of the Component Mounting Subcommittee (5-21) of the Assembly and  
Joining Committee (5-20) of IPC

Users of this publication are encouraged to participate in the  
development of future revisions.

Contact:

IPC  
3000 Lakeside Drive, Suite 309S  
Bannockburn, Illinois  
60015-1249  
Tel 847 615.7100  
Fax 847 615.7105

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